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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

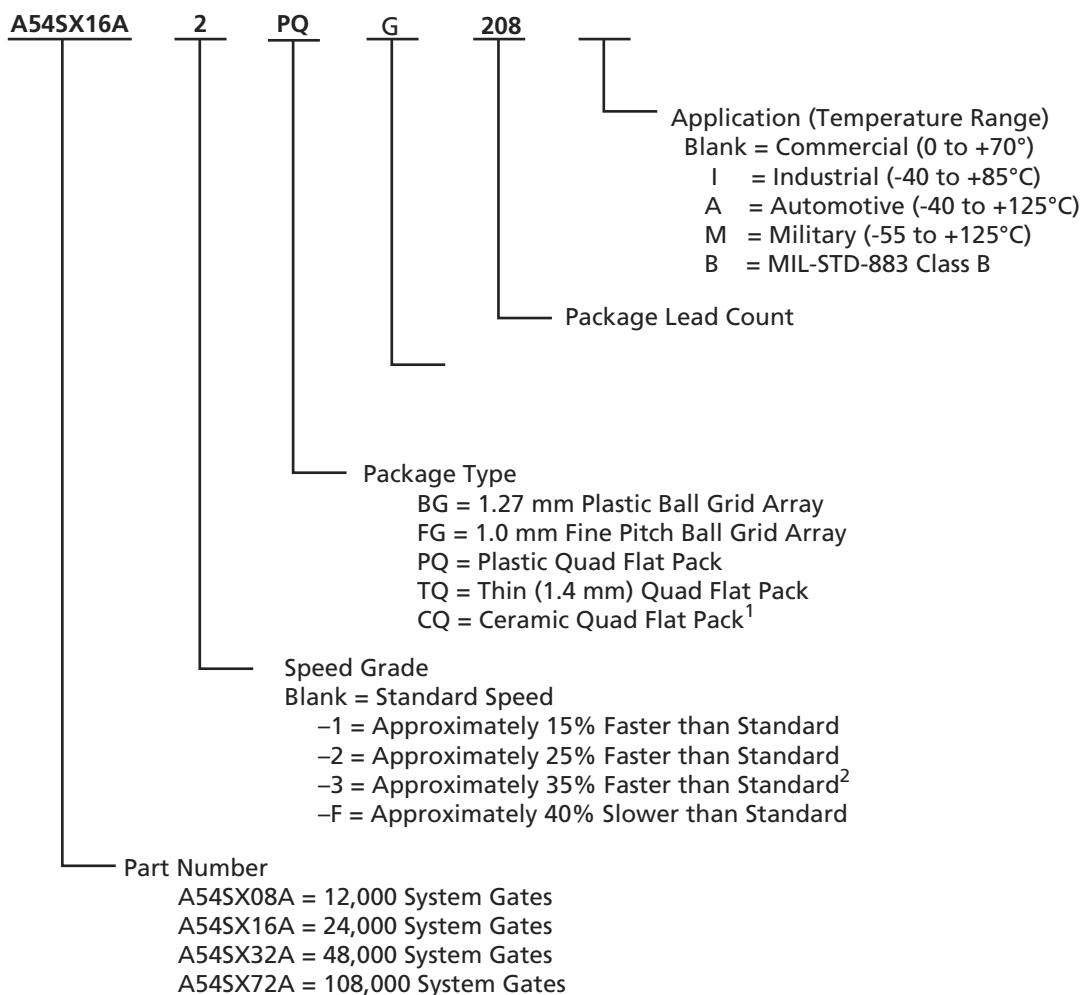
### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Active
Number of LABs/CLBs	1452
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	81
Number of Gates	24000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	100-LQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a54sx16a-ftqg100">https://www.e-xfl.com/product-detail/microchip-technology/a54sx16a-ftqg100</a>

## Ordering Information



### Notes:

1. For more information about the CQFP package options, refer to the HiRel SX-A datasheet.
2. All -3 speed grades have been discontinued.

## Device Resources

Device	User I/Os (Including Clock Buffers)								
	208-Pin PQFP	100-Pin TQFP	144-Pin TQFP	176-Pin TQFP	329-Pin PBGA	144-Pin FBGA	256-Pin FBGA	484-Pin FBGA	
A54SX08A	130	81	113	-	-	111	-	-	
A54SX16A	175	81	113	-	-	111	180	-	
A54SX32A	174	81	113	147	249	111	203	249	
A54SX72A	171	-	-	-	-	-	203	360	

**Notes:** Package Definitions: PQFP = Plastic Quad Flat Pack, TQFP = Thin Quad Flat Pack, PBGA = Plastic Ball Grid Array, FBGA = Fine Pitch Ball Grid Array

## Temperature Grade Offering

Package	A54SX08A	A54SX16A	A54SX32A	A54SX72A
PQ208	C,I,A,M	C,I,A,M	C,I,A,M	C,I,A,M
TQ100	C,I,A,M	C,I,A,M	C,I,A,M	
TQ144	C,I,A,M	C,I,A,M	C,I,A,M	
TQ176			C,I,M	
BG329			C,I,M	
FG144	C,I,A,M	C,I,A,M	C,I,A,M	
FG256		C,I,A,M	C,I,A,M	C,I,A,M
FG484			C,I,M	C,I,A,M
CQ208			C,M,B	C,M,B
CQ256			C,M,B	C,M,B

**Notes:**

1. C = Commercial
2. I = Industrial
3. A = Automotive
4. M = Military
5. B = MIL-STD-883 Class B
6. For more information regarding automotive products, refer to the SX-A Automotive Family FPGAs datasheet.
7. For more information regarding Mil-Temp and ceramic packages, refer to the HiRel SX-A Family FPGAs datasheet.

## Speed Grade and Temperature Grade Matrix

	F	Std	-1	-2	-3
Commercial	✓	✓	✓	✓	Discontinued
Industrial		✓	✓	✓	Discontinued
Automotive		✓			
Military		✓	✓		
MIL-STD-883B		✓	✓		

**Notes:**

1. For more information regarding automotive products, refer to the SX-A Automotive Family FPGAs datasheet.
2. For more information regarding Mil-Temp and ceramic packages, refer to the HiRel SX-A Family FPGAs datasheet.

Contact your Actel Sales representative for more information on availability.

# General Description

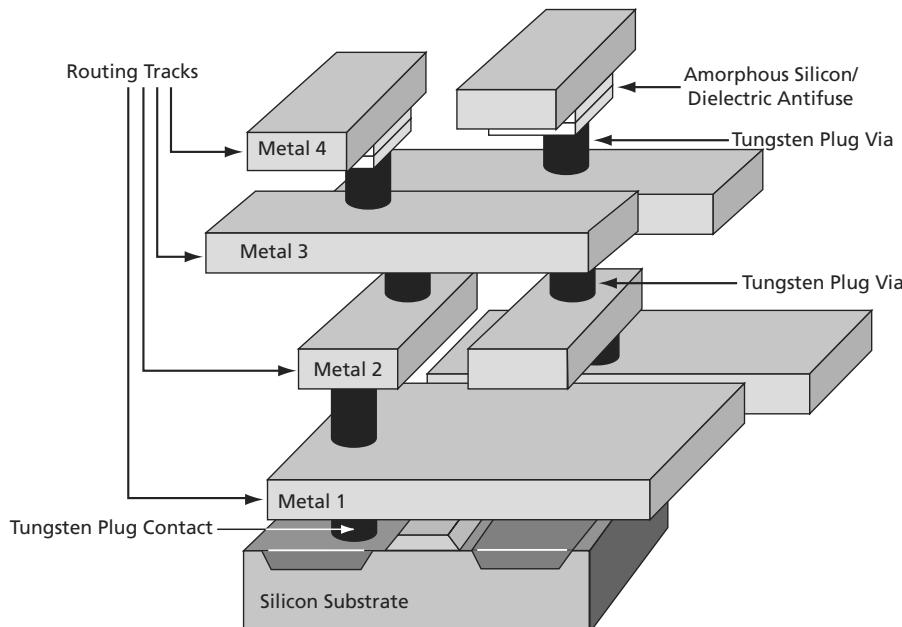
## Introduction

The Actel SX-A family of FPGAs offers a cost-effective, single-chip solution for low-power, high-performance designs. Fabricated on  $0.22\text{ }\mu\text{m} / 0.25\text{ }\mu\text{m}$  CMOS antifuse technology and with the support of 2.5 V, 3.3 V and 5 V I/Os, the SX-A is a versatile platform to integrate designs while significantly reducing time-to-market.

## SX-A Family Architecture

The SX-A family's device architecture provides a unique approach to module organization and chip routing that satisfies performance requirements and delivers the most optimal register/logic mix for a wide variety of applications.

Interconnection between these logic modules is achieved using Actel's patented metal-to-metal programmable antifuses interconnect elements (Figure 1-1). The antifuses are normally open circuit and, when programmed, form a permanent low-impedance connection.



**Note:** The A54SX72A device has four layers of metal with the antifuse between Metal 3 and Metal 4. The A54SX08A, A54SX16A, and A54SX32A devices have three layers of metal with the antifuse between Metal 2 and Metal 3.

Figure 1-1 • SX-A Family Interconnect Elements

## Logic Module Design

The SX-A family architecture is described as a “sea-of-modules” architecture because the entire floor of the device is covered with a grid of logic modules with virtually no chip area lost to interconnect elements or routing. The Actel SX-A family provides two types of logic modules: the register cell (R-cell) and the combinatorial cell (C-cell).

The R-cell contains a flip-flop featuring asynchronous clear, asynchronous preset, and clock enable, using the S0 and S1 lines control signals (Figure 1-2). The R-cell registers feature programmable clock polarity selectable on a register-by-register basis. This provides additional flexibility while allowing mapping of synthesized functions into the SX-A FPGA. The clock source for the R-cell can be chosen from either the hardwired clock, the routed clocks, or internal logic.

The C-cell implements a range of combinatorial functions of up to five inputs (Figure 1-3). Inclusion of the DB input and its associated inverter function allows up to 4,000

different combinatorial functions to be implemented in a single module. An example of the flexibility enabled by the inversion capability is the ability to integrate a 3-input exclusive-OR function into a single C-cell. This facilitates construction of 9-bit parity-tree functions with 1.9 ns propagation delays.

## Module Organization

All C-cell and R-cell logic modules are arranged into horizontal banks called Clusters. There are two types of Clusters: Type 1 contains two C-cells and one R-cell, while Type 2 contains one C-cell and two R-cells.

Clusters are grouped together into SuperClusters (Figure 1-4 on page 1-3). SuperCluster 1 is a two-wide grouping of Type 1 Clusters. SuperCluster 2 is a two-wide group containing one Type 1 Cluster and one Type 2 Cluster. SX-A devices feature more SuperCluster 1 modules than SuperCluster 2 modules because designers typically require significantly more combinatorial logic than flip-flops.

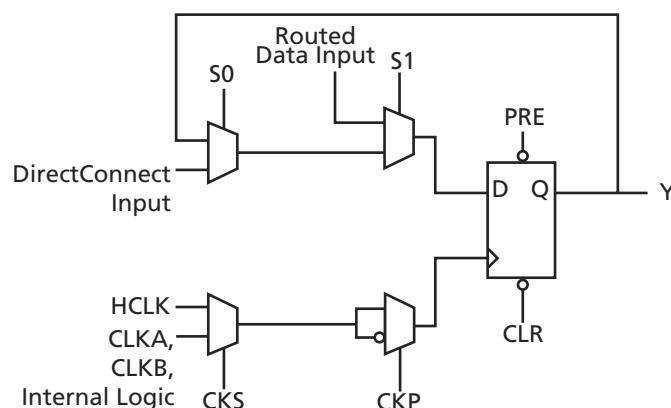


Figure 1-2 • R-Cell

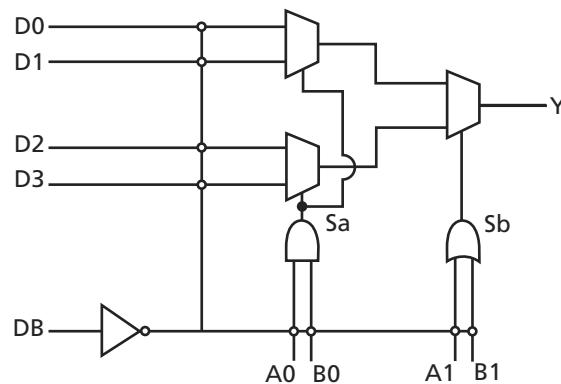


Figure 1-3 • C-Cell

## Probing Capabilities

SX-A devices also provide an internal probing capability that is accessed with the JTAG pins. The Silicon Explorer II diagnostic hardware is used to control the TDI, TCK, TMS, and TDO pins to select the desired nets for debugging. The user assigns the selected internal nets in Actel Silicon Explorer II software to the PRA/PRB output pins for observation. Silicon Explorer II automatically places the device into JTAG mode. However, probing functionality is only activated when the TRST pin is driven high or left floating, allowing the internal pull-up resistor to pull TRST High. If the TRST pin is held Low, the TAP controller remains in the Test-Logic-Reset state so no probing can be performed. However, the user must drive the TRST pin High or allow the internal pull-up resistor to pull TRST High.

When selecting the **Reserve Probe Pin** box as shown in Figure 1-12 on page 1-9, direct the layout tool to reserve the PRA and PRB pins as dedicated outputs for probing. This **Reserve** option is merely a guideline. If the designer assigns user I/Os to the PRA and PRB pins and selects the **Reserve Probe Pin** option, Designer Layout will override the **Reserve Probe Pin** option and place the user I/Os on those pins.

To allow probing capabilities, the security fuse must not be programmed. Programming the security fuse disables the JTAG and probe circuitry. Table 1-9 summarizes the possible device configurations for probing once the device leaves the Test-Logic-Reset JTAG state.

Table 1-9 • Device Configuration Options for Probe Capability (TRST Pin Reserved)

JTAG Mode	TRST <sup>1</sup>	Security Fuse Programmed	PRA, PRB <sup>2</sup>	TDI, TCK, TDO <sup>2</sup>
Dedicated	Low	No	User I/O <sup>3</sup>	JTAG Disabled
	High	No	Probe Circuit Outputs	JTAG I/O
Flexible	Low	No	User I/O <sup>3</sup>	User I/O <sup>3</sup>
	High	No	Probe Circuit Outputs	JTAG I/O
		Yes	Probe Circuit Secured	Probe Circuit Secured

**Notes:**

1. If the TRST pin is not reserved, the device behaves according to TRST = High as described in the table.
2. Avoid using the TDI, TCK, TDO, PRA, and PRB pins as input or bidirectional ports. Since these pins are active during probing, input signals will not pass through these pins and may cause contention.
3. If no user signal is assigned to these pins, they will behave as unused I/Os in this mode. Unused pins are automatically tristated by the Designer software.

# Detailed Specifications

## Operating Conditions

Table 2-1 • Absolute Maximum Ratings

Symbol	Parameter	Limits	Units
$V_{CCI}$	DC Supply Voltage for I/Os	-0.3 to +6.0	V
$V_{CCA}$	DC Supply Voltage for Arrays	-0.3 to +3.0	V
$V_I$	Input Voltage	-0.5 to +5.75	V
$V_O$	Output Voltage	-0.5 to + $V_{CCI}$ + 0.5	V
$T_{STG}$	Storage Temperature	-65 to +150	°C

**Note:** \*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Devices should not be operated outside the "Recommended Operating Conditions".

Table 2-2 • Recommended Operating Conditions

Parameter	Commercial	Industrial	Units
Temperature Range	0 to +70	-40 to +85	°C
2.5 V Power Supply Range ( $V_{CCA}$ and $V_{CCI}$ )	2.25 to 2.75	2.25 to 2.75	V
3.3 V Power Supply Range ( $V_{CCI}$ )	3.0 to 3.6	3.0 to 3.6	V
5 V Power Supply Range ( $V_{CCI}$ )	4.75 to 5.25	4.75 to 5.25	V

## Typical SX-A Standby Current

Table 2-3 • Typical Standby Current for SX-A at 25°C with  $V_{CCA} = 2.5$  V

Product	$V_{CCI} = 2.5$ V	$V_{CCI} = 3.3$ V	$V_{CCI} = 5$ V
A54SX08A	0.8 mA	1.0 mA	2.9 mA
A54SX16A	0.8 mA	1.0 mA	2.9 mA
A54SX32A	0.9 mA	1.0 mA	3.0 mA
A54SX72A	3.6 mA	3.8 mA	4.5 mA

Table 2-4 • Supply Voltages

$V_{CCA}$	$V_{CCI}^*$	Maximum Input Tolerance	Maximum Output Drive
2.5 V	2.5 V	5.75 V	2.7 V
2.5 V	3.3 V	5.75 V	3.6 V
2.5 V	5 V	5.75 V	5.25 V

**Note:** \*3.3 V PCI is not 5 V tolerant due to the clamp diode, but instead is 3.3 V tolerant.

Figure 2-2 shows the 3.3 V PCI V/I curve and the minimum and maximum PCI drive characteristics of the SX-A family.

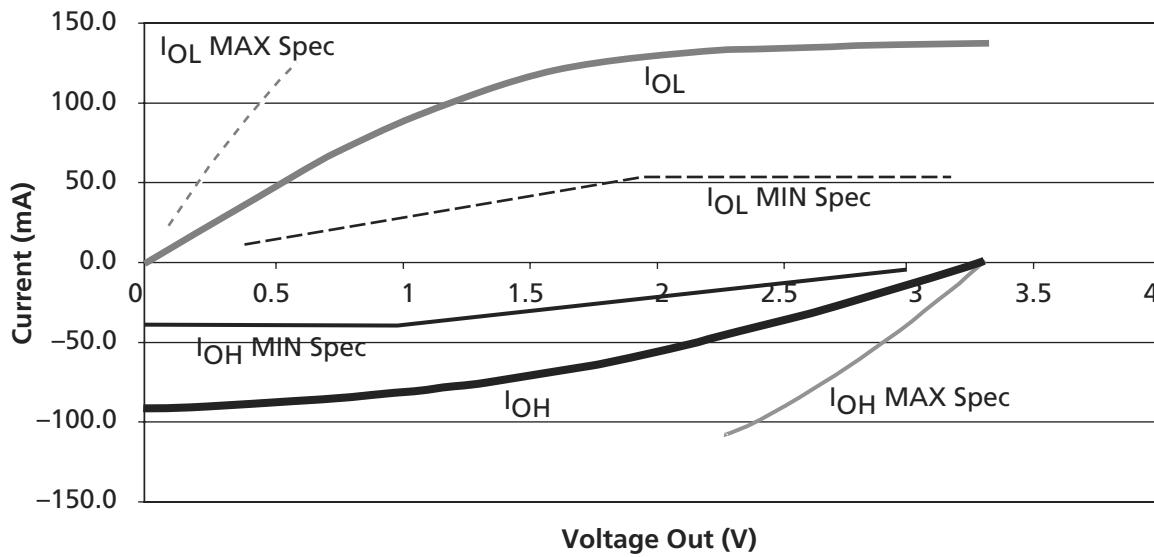


Figure 2-2 • 3.3 V PCI V/I Curve for SX-A Family

$$I_{OH} = (98.0V_{CCI}) * (V_{OUT} - V_{CCI}) * (V_{OUT} + 0.4V_{CCI})$$

for  $0.7V_{CCI} < V_{OUT} < V_{CCI}$

EQ 2-3

$$I_{OL} = (256V_{CCI}) * V_{OUT} * (V_{CCI} - V_{OUT})$$

for  $0V < V_{OUT} < 0.18V_{CCI}$

EQ 2-4

## Output Buffer Delays

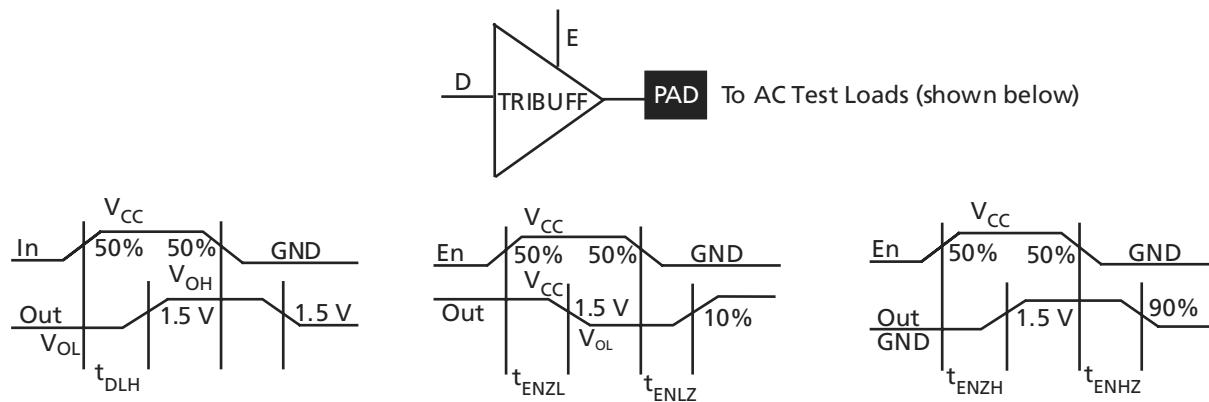


Figure 2-4 • Output Buffer Delays

## AC Test Loads

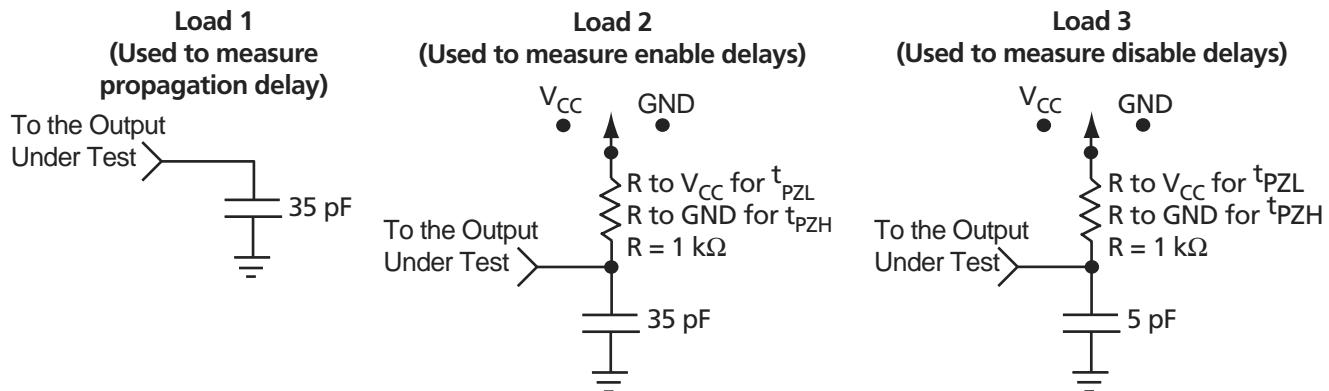


Figure 2-5 • AC Test Loads

Table 2-15 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>								
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)		1.4		1.6		1.8	2.6
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.3		1.5		1.7	2.4
$t_{HPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		ns
$t_{HPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		ns
$t_{HCKSW}$	Maximum Skew		0.4		0.4		0.5	0.7
$t_{HP}$	Minimum Period	3.2		3.6		4.2	5.8	ns
$f_{HMAX}$	Maximum Frequency		313		278		238	172
<b>Routed Array Clock Networks</b>								
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)		1.0		1.1		1.3	1.8
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.1		1.2		1.4	2.0
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)		1.0		1.1		1.3	1.8
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		1.1		1.2		1.4	2.0
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)		1.1		1.2		1.4	2.0
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		1.3		1.5		1.7	2.4
$t_{RPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		ns
$t_{RPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		ns
$t_{RCKSW}$	Maximum Skew (Light Load)		0.7		0.8		0.9	1.3
$t_{RCKSW}$	Maximum Skew (50% Load)		0.7		0.8		0.9	1.3
$t_{RCKSW}$	Maximum Skew (100% Load)		0.9		1.0		1.2	1.7

Table 2-16 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>		<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>									
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)		1.3		1.5		1.7		2.6 ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)		1.1		1.3		1.5		2.2 ns
$t_{HPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9	ns
$t_{HCKSW}$	Maximum Skew		0.4		0.5		0.5		0.8 ns
$t_{HP}$	Minimum Period	3.2		3.6		4.2		5.8	ns
$f_{HMAX}$	Maximum Frequency		313		278		238		172 MHz
<b>Routed Array Clock Networks</b>									
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)		0.8		0.9		1.1		1.5 ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)		1.1		1.2		1.4		2 ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)		0.8		0.9		1.1		1.5 ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)		1.1		1.2		1.4		2 ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)		1.1		1.2		1.4		1.9 ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)		1.2		1.3		1.6		2.2 ns
$t_{RPWH}$	Minimum Pulse Width High	1.6		1.8		2.1		2.9	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.6		1.8		2.1		2.9	ns
$t_{RCKSW}$	Maximum Skew (Light Load)		0.7		0.8		0.9		1.3 ns
$t_{RCKSW}$	Maximum Skew (50% Load)		0.7		0.8		0.9		1.3 ns
$t_{RCKSW}$	Maximum Skew (100% Load)		0.8		0.9		1.1		1.5 ns

Table 2-19 • A54SX08A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>3.3 V PCI Output Module Timing<sup>1</sup></b>								
$t_{DLH}$	Data-to-Pad Low to High	2.2	2.4	2.9	4.0	ns		
$t_{DHL}$	Data-to-Pad High to Low	2.3	2.6	3.1	4.3	ns		
$t_{ENZL}$	Enable-to-Pad, Z to L	1.7	1.9	2.2	3.1	ns		
$t_{ENZH}$	Enable-to-Pad, Z to H	2.2	2.4	2.9	4.0	ns		
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.8	3.2	3.8	5.3	ns		
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.3	2.6	3.1	4.3	ns		
$d_{TLH}^2$	Delta Low to High	0.03	0.03	0.04	0.045	ns/pF		
$d_{THL}^2$	Delta High to Low	0.015	0.015	0.015	0.025	ns/pF		
<b>3.3 V LVTTL Output Module Timing<sup>3</sup></b>								
$t_{DLH}$	Data-to-Pad Low to High	3.0	3.4	4.0	5.6	ns		
$t_{DHL}$	Data-to-Pad High to Low	3.0	3.3	3.9	5.5	ns		
$t_{DHLS}$	Data-to-Pad High to Low—low slew	10.4	11.8	13.8	19.3	ns		
$t_{ENZL}$	Enable-to-Pad, Z to L	2.6	2.9	3.4	4.8	ns		
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	18.9	21.3	25.4	34.9	ns		
$t_{ENZH}$	Enable-to-Pad, Z to H	3	3.4	4	5.6	ns		
$t_{ENLZ}$	Enable-to-Pad, L to Z	3.3	3.7	4.4	6.2	ns		
$t_{ENHZ}$	Enable-to-Pad, H to Z	3	3.3	3.9	5.5	ns		
$d_{TLH}^2$	Delta Low to High	0.03	0.03	0.04	0.045	ns/pF		
$d_{THL}^2$	Delta High to Low	0.015	0.015	0.015	0.025	ns/pF		
$d_{THLS}^2$	Delta High to Low—low slew	0.053	0.067	0.073	0.107	ns/pF		

**Notes:**

1. Delays based on 10 pF loading and 25  $\Omega$  resistance.
2. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[|LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[|LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
3. Delays based on 35 pF loading.

Table 2-21 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions,  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>C-Cell Propagation Delays<sup>2</sup></b>										
$t_{PD}$	Internal Array Module	0.9	1.0	1.2	1.4	1.6	1.8	1.9	ns	
<b>Predicted Routing Delays<sup>3</sup></b>										
$t_{DC}$	FO = 1 Routing Delay, Direct Connect	0.1	0.1	0.1	0.1	0.1	0.1	0.1	ns	
$t_{FC}$	FO = 1 Routing Delay, Fast Connect	0.3	0.3	0.3	0.4	0.4	0.4	0.6	ns	
$t_{RD1}$	FO = 1 Routing Delay	0.3	0.3	0.4	0.5	0.5	0.5	0.6	ns	
$t_{RD2}$	FO = 2 Routing Delay	0.4	0.5	0.5	0.6	0.6	0.6	0.8	ns	
$t_{RD3}$	FO = 3 Routing Delay	0.5	0.6	0.7	0.8	0.8	0.8	1.1	ns	
$t_{RD4}$	FO = 4 Routing Delay	0.7	0.8	0.9	1.0	1.0	1.0	1.4	ns	
$t_{RD8}$	FO = 8 Routing Delay	1.2	1.4	1.5	1.8	1.8	1.8	2.5	ns	
$t_{RD12}$	FO = 12 Routing Delay	1.7	2	2.2	2.6	2.6	2.6	3.6	ns	
<b>R-Cell Timing</b>										
$t_{RCO}$	Sequential Clock-to-Q	0.6	0.7	0.8	0.9	0.9	1.0	1.3	ns	
$t_{CLR}$	Asynchronous Clear-to-Q	0.5	0.6	0.6	0.8	0.8	1.0	1.0	ns	
$t_{PRESET}$	Asynchronous Preset-to-Q	0.7	0.8	0.8	1.0	1.0	1.4	1.4	ns	
$t_{SUD}$	Flip-Flop Data Input Set-Up	0.7	0.8	0.9	1.0	1.0	1.4	1.4	ns	
$t_{HD}$	Flip-Flop Data Input Hold	0.0	0.0	0.0	0.0	0.0	0.0	0.0	ns	
$t_{WASYN}$	Asynchronous Pulse Width	1.3	1.5	1.6	1.9	1.9	2.7	2.7	ns	
$t_{RECASYN}$	Asynchronous Recovery Time	0.3	0.4	0.4	0.5	0.5	0.7	0.7	ns	
$t_{HASYN}$	Asynchronous Removal Time	0.3	0.3	0.3	0.4	0.4	0.6	0.6	ns	
$t_{MPW}$	Clock Minimum Pulse Width	1.4	1.7	1.9	2.2	2.2	3.0	3.0	ns	
<b>Input Module Propagation Delays</b>										
$t_{INYH}$	Input Data Pad to Y High 2.5 V LVC MOS	0.5	0.6	0.7	0.8	0.8	1.1	1.1	ns	
$t_{INYL}$	Input Data Pad to Y Low 2.5 V LVC MOS	0.8	0.9	1.0	1.1	1.1	1.6	1.6	ns	
$t_{INYH}$	Input Data Pad to Y High 3.3 V PCI	0.5	0.6	0.6	0.7	0.7	1.0	1.0	ns	
$t_{INYL}$	Input Data Pad to Y Low 3.3 V PCI	0.7	0.8	0.9	1.0	1.0	1.4	1.4	ns	
$t_{INYH}$	Input Data Pad to Y High 3.3 V LV TTL	0.7	0.7	0.8	1.0	1.0	1.4	1.4	ns	
$t_{INYL}$	Input Data Pad to Y Low 3.3 V LV TTL	0.9	1.1	1.2	1.4	1.4	2.0	2.0	ns	

**Notes:**

1. All -3 speed grades have been discontinued.
2. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
3. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.

Table 2-22 • A54SX16A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 2.25\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.2	1.4	1.6	1.8	2.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.0	1.1	1.2	1.5	2.2	ns
$t_{HPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{HCKSW}$	Maximum Skew	0.3	0.3	0.4	0.4	0.7	ns
$t_{HP}$	Minimum Period	2.8	3.4	3.8	4.4	6.0	ns
$f_{HMAX}$	Maximum Frequency	357	294	263	227	167	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.0	1.2	1.3	1.6	2.2	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.1	1.3	1.5	1.7	2.4	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.3	1.5	1.7	2.0	2.8	ns
$t_{RPWH}$	Minimum Pulse Width High	1.4	1.7	1.9	2.2	3.0	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.4	1.7	1.9	2.2	3.0	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	0.8	0.9	1.0	1.2	1.7	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.0	1.1	1.3	1.5	2.1	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-35 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions,  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>	
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>		
<b>C-Cell Propagation Delays<sup>2</sup></b>											
$t_{PD}$	Internal Array Module	1.0		1.1		1.3		1.5		2.0	ns
<b>Predicted Routing Delays<sup>3</sup></b>											
$t_{DC}$	FO = 1 Routing Delay, Direct Connect	0.1		0.1		0.1		0.1		ns	
$t_{FC}$	FO = 1 Routing Delay, Fast Connect	0.3		0.3		0.3		0.4		0.6	ns
$t_{RD1}$	FO = 1 Routing Delay	0.3		0.3		0.4		0.5		0.7	ns
$t_{RD2}$	FO = 2 Routing Delay	0.4		0.5		0.6		0.7		1	ns
$t_{RD3}$	FO = 3 Routing Delay	0.5		0.7		0.8		0.9		1.3	ns
$t_{RD4}$	FO = 4 Routing Delay	0.7		0.9		1		1.1		1.5	ns
$t_{RD8}$	FO = 8 Routing Delay	1.2		1.5		1.7		2.1		2.9	ns
$t_{RD12}$	FO = 12 Routing Delay	1.7		2.2		2.5		3		4.2	ns
<b>R-Cell Timing</b>											
$t_{RCO}$	Sequential Clock-to-Q	0.7		0.8		0.9		1.1		1.5	ns
$t_{CLR}$	Asynchronous Clear-to-Q	0.6		0.7		0.7		0.9		1.2	ns
$t_{PRESET}$	Asynchronous Preset-to-Q	0.7		0.8		0.8		1.0		1.4	ns
$t_{SUD}$	Flip-Flop Data Input Set-Up	0.7		0.8		0.9		1.0		1.4	ns
$t_{HD}$	Flip-Flop Data Input Hold	0.0		0.0		0.0		0.0		0.0	ns
$t_{WASYN}$	Asynchronous Pulse Width	1.3		1.5		1.7		2.0		2.8	ns
$t_{RECASYN}$	Asynchronous Recovery Time	0.3		0.4		0.4		0.5		0.7	ns
$t_{HASYN}$	Asynchronous Hold Time	0.3		0.3		0.3		0.4		0.6	ns
$t_{MPW}$	Clock Minimum Pulse Width	1.5		1.7		2.0		2.3		3.2	ns
<b>Input Module Propagation Delays</b>											
$t_{INYH}$	Input Data Pad to Y High 2.5 V LVC MOS	0.6		0.7		0.8		0.9		1.3	ns
$t_{INYL}$	Input Data Pad to Y Low 2.5 V LVC MOS	0.8		1.0		1.1		1.3		1.7	ns
$t_{INYH}$	Input Data Pad to Y High 3.3 V PCI	0.6		0.7		0.7		0.9		1.2	ns
$t_{INYL}$	Input Data Pad to Y Low 3.3 V PCI	0.7		0.8		0.9		1.0		1.4	ns
$t_{INYH}$	Input Data Pad to Y High 3.3 V LV TTL	0.7		0.7		0.8		1.0		1.4	ns
$t_{INYL}$	Input Data Pad to Y Low 3.3 V LV TTL	1.0		1.2		1.3		1.5		2.1	ns

**Notes:**

1. All -3 speed grades have been discontinued.
2. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
3. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.

Table 2-37 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>Dedicated (Hardwired) Array Clock Networks</b>							
$t_{HCKH}$	Input Low to High (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.8	ns
$t_{HCKL}$	Input High to Low (Pad to R-cell Input)	1.7	1.9	2.1	2.5	3.8	ns
$t_{HPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{HPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{HCKSW}$	Maximum Skew	1.4	1.6	1.8	2.1	3.3	ns
$t_{HP}$	Minimum Period	3.0	3.4	4.0	4.6	6.4	ns
$f_{HMAX}$	Maximum Frequency	333	294	250	217	156	MHz
<b>Routed Array Clock Networks</b>							
$t_{RCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	2.2	2.6	2.9	3.4	4.8	ns
$t_{RCKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	2.8	3.3	3.7	4.3	6.0	ns
$t_{RCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	2.4	2.8	3.2	3.7	5.2	ns
$t_{RCKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	2.9	3.4	3.8	4.5	6.2	ns
$t_{RCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	2.6	3.0	3.4	4.0	5.6	ns
$t_{RCKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	3.1	3.6	4.1	4.8	6.7	ns
$t_{RPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{RPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{RCKSW}$	Maximum Skew (Light Load)	1.9	2.2	2.5	3	4.1	ns
$t_{RCKSW}$	Maximum Skew (50% Load)	1.9	2.1	2.4	2.8	3.9	ns
$t_{RCKSW}$	Maximum Skew (100% Load)	1.9	2.1	2.4	2.8	3.9	ns
<b>Quadrant Array Clock Networks</b>							
$t_{QCKH}$	Input Low to High (Light Load) (Pad to R-cell Input)	1.3	1.5	1.7	1.9	2.7	ns
$t_{QCHKL}$	Input High to Low (Light Load) (Pad to R-cell Input)	1.3	1.5	1.7	2	2.8	ns
$t_{QCKH}$	Input Low to High (50% Load) (Pad to R-cell Input)	1.5	1.7	1.9	2.2	3.1	ns
$t_{QCHKL}$	Input High to Low (50% Load) (Pad to R-cell Input)	1.5	1.8	2	2.3	3.2	ns

**Note:** \*All -3 speed grades have been discontinued.

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
1	GND	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O	I/O
4	NC	I/O	I/O	I/O
5	I/O	I/O	I/O	I/O
6	NC	I/O	I/O	I/O
7	I/O	I/O	I/O	I/O
8	I/O	I/O	I/O	I/O
9	I/O	I/O	I/O	I/O
10	I/O	I/O	I/O	I/O
11	TMS	TMS	TMS	TMS
12	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
13	I/O	I/O	I/O	I/O
14	NC	I/O	I/O	I/O
15	I/O	I/O	I/O	I/O
16	I/O	I/O	I/O	I/O
17	NC	I/O	I/O	I/O
18	I/O	I/O	I/O	GND
19	I/O	I/O	I/O	V <sub>CCA</sub>
20	NC	I/O	I/O	I/O
21	I/O	I/O	I/O	I/O
22	I/O	I/O	I/O	I/O
23	NC	I/O	I/O	I/O
24	I/O	I/O	I/O	I/O
25	NC	NC	NC	I/O
26	GND	GND	GND	GND
27	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
28	GND	GND	GND	GND
29	I/O	I/O	I/O	I/O
30	TRST, I/O	TRST, I/O	TRST, I/O	TRST, I/O
31	NC	I/O	I/O	I/O
32	I/O	I/O	I/O	I/O
33	I/O	I/O	I/O	I/O
34	I/O	I/O	I/O	I/O
35	NC	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
36	I/O	I/O	I/O	I/O
37	I/O	I/O	I/O	I/O
38	I/O	I/O	I/O	I/O
39	NC	I/O	I/O	I/O
40	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
41	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
42	I/O	I/O	I/O	I/O
43	I/O	I/O	I/O	I/O
44	I/O	I/O	I/O	I/O
45	I/O	I/O	I/O	I/O
46	I/O	I/O	I/O	I/O
47	I/O	I/O	I/O	I/O
48	NC	I/O	I/O	I/O
49	I/O	I/O	I/O	I/O
50	NC	I/O	I/O	I/O
51	I/O	I/O	I/O	I/O
52	GND	GND	GND	GND
53	I/O	I/O	I/O	I/O
54	I/O	I/O	I/O	I/O
55	I/O	I/O	I/O	I/O
56	I/O	I/O	I/O	I/O
57	I/O	I/O	I/O	I/O
58	I/O	I/O	I/O	I/O
59	I/O	I/O	I/O	I/O
60	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
61	NC	I/O	I/O	I/O
62	I/O	I/O	I/O	I/O
63	I/O	I/O	I/O	I/O
64	NC	I/O	I/O	I/O
65	I/O	I/O	NC	I/O
66	I/O	I/O	I/O	I/O
67	NC	I/O	I/O	I/O
68	I/O	I/O	I/O	I/O
69	I/O	I/O	I/O	I/O
70	NC	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
141	NC	I/O	I/O	I/O
142	I/O	I/O	I/O	I/O
143	NC	I/O	I/O	I/O
144	I/O	I/O	I/O	I/O
145	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
146	GND	GND	GND	GND
147	I/O	I/O	I/O	I/O
148	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
149	I/O	I/O	I/O	I/O
150	I/O	I/O	I/O	I/O
151	I/O	I/O	I/O	I/O
152	I/O	I/O	I/O	I/O
153	I/O	I/O	I/O	I/O
154	I/O	I/O	I/O	I/O
155	NC	I/O	I/O	I/O
156	NC	I/O	I/O	I/O
157	GND	GND	GND	GND
158	I/O	I/O	I/O	I/O
159	I/O	I/O	I/O	I/O
160	I/O	I/O	I/O	I/O
161	I/O	I/O	I/O	I/O
162	I/O	I/O	I/O	I/O
163	I/O	I/O	I/O	I/O
164	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
165	I/O	I/O	I/O	I/O
166	I/O	I/O	I/O	I/O
167	NC	I/O	I/O	I/O
168	I/O	I/O	I/O	I/O
169	I/O	I/O	I/O	I/O
170	NC	I/O	I/O	I/O
171	I/O	I/O	I/O	I/O
172	I/O	I/O	I/O	I/O
173	NC	I/O	I/O	I/O
174	I/O	I/O	I/O	I/O
175	I/O	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
176	NC	I/O	I/O	I/O
177	I/O	I/O	I/O	I/O
178	I/O	I/O	I/O	QCLKD
179	I/O	I/O	I/O	I/O
180	CLKA	CLKA	CLKA	CLKA
181	CLKB	CLKB	CLKB	CLKB
182	NC	NC	NC	NC
183	GND	GND	GND	GND
184	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
185	GND	GND	GND	GND
186	PRA, I/O	PRA, I/O	PRA, I/O	PRA, I/O
187	I/O	I/O	I/O	V <sub>CCI</sub>
188	I/O	I/O	I/O	I/O
189	NC	I/O	I/O	I/O
190	I/O	I/O	I/O	QCLKC
191	I/O	I/O	I/O	I/O
192	NC	I/O	I/O	I/O
193	I/O	I/O	I/O	I/O
194	I/O	I/O	I/O	I/O
195	NC	I/O	I/O	I/O
196	I/O	I/O	I/O	I/O
197	I/O	I/O	I/O	I/O
198	NC	I/O	I/O	I/O
199	I/O	I/O	I/O	I/O
200	I/O	I/O	I/O	I/O
201	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
202	NC	I/O	I/O	I/O
203	NC	I/O	I/O	I/O
204	I/O	I/O	I/O	I/O
205	NC	I/O	I/O	I/O
206	I/O	I/O	I/O	I/O
207	I/O	I/O	I/O	I/O
208	TCK, I/O	TCK, I/O	TCK, I/O	TCK, I/O

<b>176-Pin TQFP</b>	
<b>Pin Number</b>	<b>A54SX32A Function</b>
145	I/O
146	I/O
147	I/O
148	I/O
149	I/O
150	I/O
151	I/O
152	CLKA
153	CLKB
154	NC
155	GND
156	V <sub>CCA</sub>
157	PRA, I/O
158	I/O
159	I/O
160	I/O
161	I/O
162	I/O
163	I/O
164	I/O
165	I/O
166	I/O
167	I/O
168	I/O
169	V <sub>CCI</sub>
170	I/O
171	I/O
172	I/O
173	I/O
174	I/O
175	I/O
176	TCK, I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
V22	I/O
V23	I/O
W1	I/O
W2	I/O
W3	I/O
W4	I/O
W20	I/O
W21	I/O
W22	I/O
W23	NC
Y1	NC
Y2	I/O
Y3	I/O
Y4	GND
Y5	I/O
Y6	I/O
Y7	I/O
Y8	I/O
Y9	I/O
Y10	I/O
Y11	I/O
Y12	V <sub>CCA</sub>
Y13	NC
Y14	I/O
Y15	I/O
Y16	I/O
Y17	I/O
Y18	I/O
Y19	I/O
Y20	GND
Y21	I/O
Y22	I/O
Y23	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
T3	I/O	I/O
T4	I/O	I/O
T5	I/O	I/O
T10	GND	GND
T11	GND	GND
T12	GND	GND
T13	GND	GND
T14	GND	GND
T15	GND	GND
T16	GND	GND
T17	GND	GND
T22	I/O	I/O
T23	I/O	I/O
T24	I/O	I/O
T25	NC*	I/O
T26	NC*	I/O
U1	I/O	I/O
U2	V <sub>CCI</sub>	V <sub>CCI</sub>
U3	I/O	I/O
U4	I/O	I/O
U5	I/O	I/O
U10	GND	GND
U11	GND	GND
U12	GND	GND
U13	GND	GND
U14	GND	GND
U15	GND	GND
U16	GND	GND
U17	GND	GND
U22	I/O	I/O
U23	I/O	I/O
U24	I/O	I/O
U25	V <sub>CCI</sub>	V <sub>CCI</sub>
U26	I/O	I/O
V1	NC*	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
V2	NC*	I/O
V3	I/O	I/O
V4	I/O	I/O
V5	I/O	I/O
V22	V <sub>CCA</sub>	V <sub>CCA</sub>
V23	I/O	I/O
V24	I/O	I/O
V25	NC*	I/O
V26	NC*	I/O
W1	I/O	I/O
W2	I/O	I/O
W3	I/O	I/O
W4	I/O	I/O
W5	I/O	I/O
W22	I/O	I/O
W23	V <sub>CCA</sub>	V <sub>CCA</sub>
W24	I/O	I/O
W25	NC*	I/O
W26	NC*	I/O
Y1	NC*	I/O
Y2	NC*	I/O
Y3	I/O	I/O
Y4	I/O	I/O
Y5	NC*	I/O
Y22	I/O	I/O
Y23	I/O	I/O
Y24	V <sub>CCI</sub>	V <sub>CCI</sub>
Y25	I/O	I/O
Y26	I/O	I/O

**Note:** \*These pins must be left floating on the A54SX32A device.